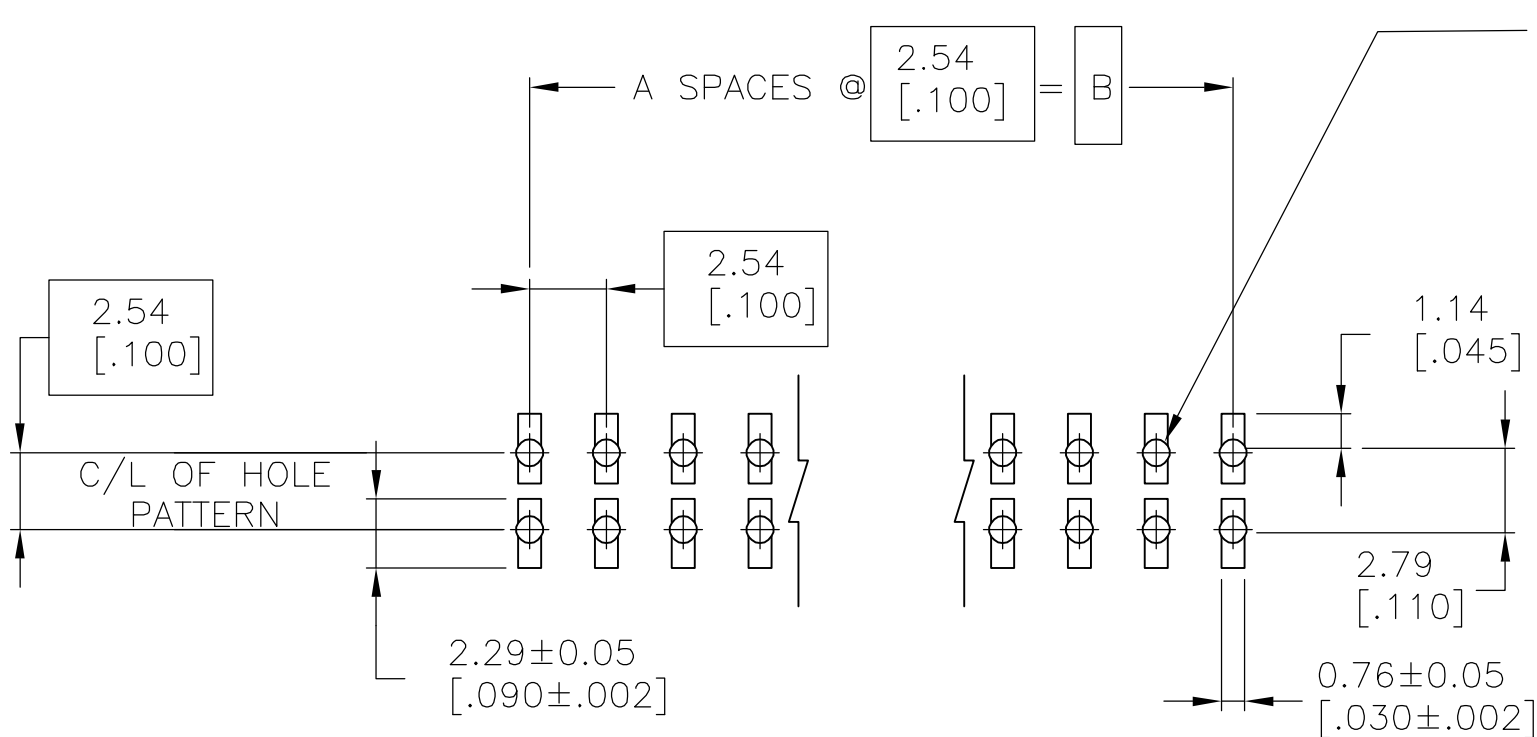
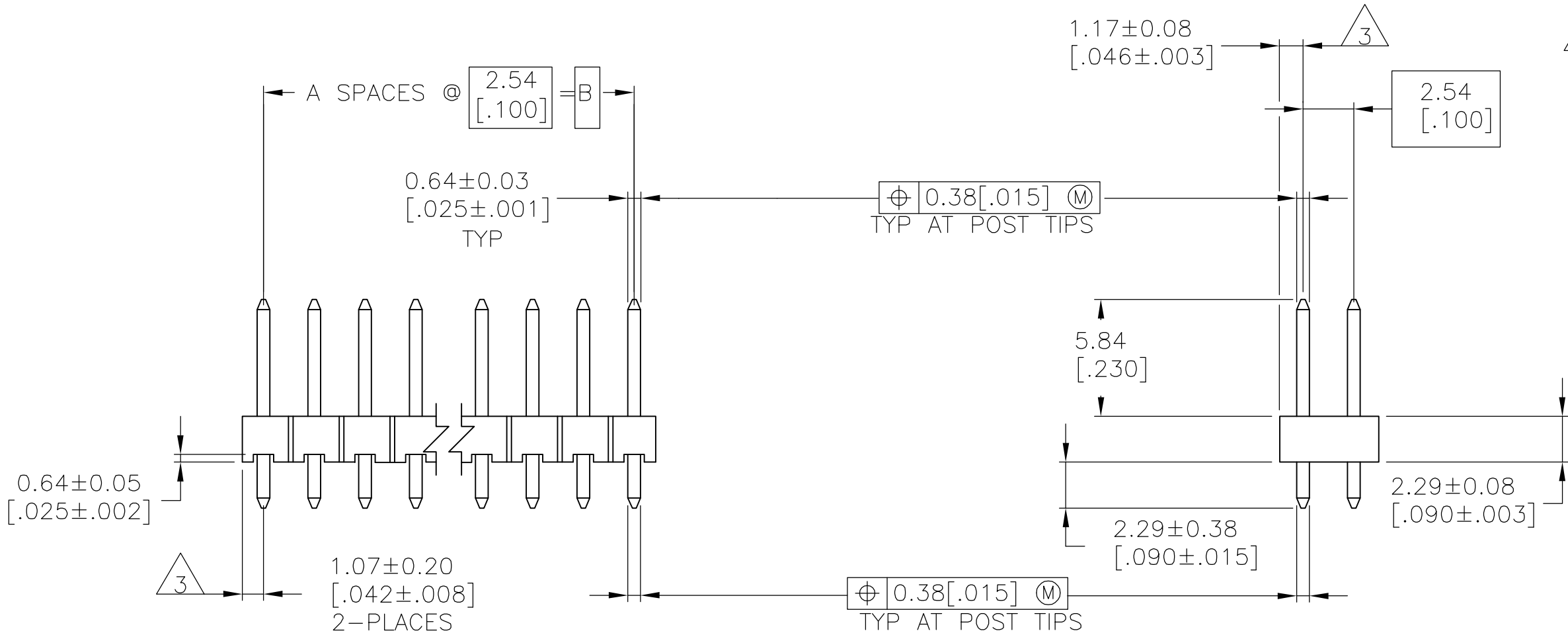
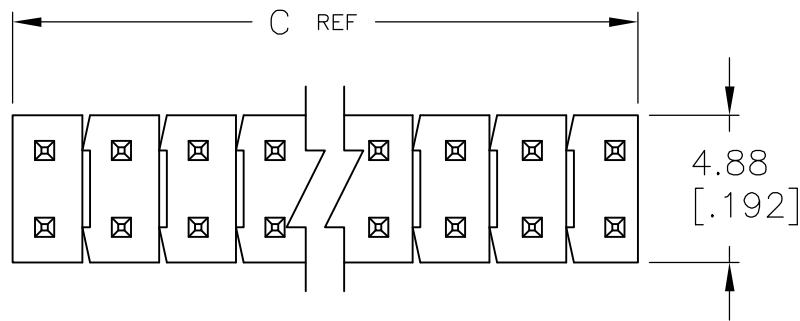


LOC	DIST	REVISIONS				
		P	LTR	DESCRIPTION	DATE	DWN APVD
AD	00		B	EC 0G3C 0169 05	21APR05	BSV JLG



RECOMMENDED PC BOARD MOUNTING DIMENSIONS
FOR 1.60 [.063] THICK PC BOARD AND
0.30 [.012] STENCIL THICK.

1. ASSEMBLY MAY BE BROKEN TO THE DESIRED NUMBER OF POSITIONS
2. TRUE POSITION TOLERANCE OF THE POST TIPS APPLIES WHEN THE HEADER IS HELD FLAT AGAINST THE PRINTED CIRCUIT BOARD
3. THE NOTED DIMENSIONS APPLY AT THE INTERSECTION OF THE POST AND HOUSING
4. POST PLATING: 0.00254–0.00508 [.000100–.000200] MATTE TIN–LEAD OVER 0.00127 [.000050] NICKEL ENTIRE POST.
5. HOUSING MATERIAL: LIQUID CRYSTAL POLYMER. COLOR: BLACK.
6. POST MATERIAL: PHOSPHOR BRONZE.
7. PART PACKAGED IN TUBES.
8. POST PLATING: 0.00254–0.00508 [.000100–.000200] MATTE TIN OVER 0.00127 [.000050] NICKEL ENTIRE POST.

8	12.29 [.484]	10.16 [.400]	4	10	5–147255–2
8	7.21 [.284]	5.08 [.200]	2	6	5–147255–1
4	12.29 [.484]	10.16 [.400]	4	10	147255–2
4	7.21 [.284]	5.08 [.200]	2	6	147255–1
PLATING	C	B	A	NO. OF POSITIONS	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN B. HAYMAKER 13APR99	tyco Electronics Tyco Electronics Corporation Harrisburg, Pa 17105–3608		
DIMENSIONS: mm [INCHES]		CHK J. GESFORD 13APR99			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD J. GESFORD 13APR99	NAME		
0 PLC ± – 1 PLC ± – 2 PLC ± – 3 PLC ± 0.13 [.005] 4 PLC ± – ANGLES ± – FINISH		PRODUCT SPEC APPLICATION SPEC WEIGHT –	HEADER ASSEMBLY, HIGH TEMPERATURE, DOUBLE ROW, BREAKAWAY, VERTICAL, MOD II, AMPMODU		
MATERIAL		SEE TABLE	SIZE A2	CAGE CODE 00779	DRAWING NO C=147255
			RESTRICTED TO		
			CUSTOMER DRAWING		
			SCALE 4:1	SHEET 1 OF 1	REV B

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